

ABSTRACT

[Abstract]

[Object] Provided are a carrier with which high-quality substrates can be obtained at a higher yield than with a conventional method, and a method for manufacturing a substrate using this carrier.

[Solution] A carrier 104 according to the present invention is a carrier for polishing or grinding having a holding hole 122 for holding a substrate (for example, a glass substrate 102). A plurality of protrusions 136 containing glass as a main component are present in at least one portion of a region of at least one surface of the carrier.

[Selected Figure] Fig. 2